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FORM PTO-1449 Atty. Docket No.: 55463/101/103

Serial No.:

AUG APPLICANT'S INFORMATION DISCLOSURE STATEMENT

Applicant: Wayne A. Bonin

Filing Date

Group Art:

August 1, 1996

-2605 2212

U.S.	PATENT	DOCUMENTS
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		I. 500 C. 1					
Exam Init		Document No.	Date	Name	Class	Sub Class	Filing Date If Appropriate
Den	AA	3,307,407	03/07/67	Berg et al.	73	432	
Mu_	AB	3,314,493	04/18/67	Kennedy	177	210	
Dun	AC	3,418,546	12/24/68	Beavers et al.	317	246	
D1_	AD	4,040,118	08/02/77	Johnston	361	283	
D4_	AE	4,089,036	05/09/78	Geronime	361	283	
Ja-	AF	4,196,632	04/08/80	Sikorra	73	718	
Dr-	AG	4,237,989	12/09/80	Lewis	177	210	
Dr-	АН	4,294,321	10/13/81	Wittlinger et al.	177	210 FP	
Den	AI	4,310,806	01/12/82	Ogasawara	331	40	
P4-	AJ	4,479,392	10/30/84	Froeb et al.	73	862.68	
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MALL	G3.	5,115,291	05/19/92	Stokes	357	26	
2 AUG	BA	5,128,671	07/07/92	Thomas, Jr.	341	20	
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D1-	вн	5,381,300	01/10/95	Thomas et al.	361	280	
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EXAMINER: DATE CONSIDERED: / @ November 1976

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